WHAT IS CLAIMED IS:

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1. A mesh structure disposed between a plurality of anode units and cathode units of a tetraode field emission display, comprising:

a first conductive layer to serve as a converging electrode layer having a proximal surface facing the anode units and a distal surface opposing to the proximal surface, the first conductive plate comprising a plurality of first apertures extending therethrough;

a glass plate formed on the proximal surface of the first conductive layer to serve as a spacer, the glass plate including a plurality of second apertures extending therethrough;

an insulation layer formed on the distal surface of the first conductive layer; and

a second conductive layer formed on the insulation layer to serve as a gate electrode layer, the second conductive layer having a proximal surface facing the cathode units and a distal surface opposing to the proximal surface, wherein the second conductive layer includes a plurality of third apertures extending therethrough and aligned with the first and second apertures.

- 2. The mesh structure of Claim 1, wherein each second aperture is aligned with one corresponding first aperture.
- 3. The mesh structure of Claim 1, wherein each second aperture covers an opening range of a plurality of the first apertures.
 - 4. The mesh structure of Claim 1, wherein each third aperture is aligned with one corresponding first aperture.
- 5. The mesh structure of Claim 1, wherein each third aperture covers an opening range of a plurality of the first apertures.
 - 6. The mesh structure of Claim 1, wherein the insulation layer is a glass glue.

7. A mesh structure of a tetra-polar field-emission display, comprising: a converging electrode layer having an array of first apertures extending therethrough;

a spacing glass plate located adjacent to one side of the converging electrode layer, the insulation layer having a plurality of second apertures aligned with the first apertures;

an insulation layer formed on the other side of the converging electrode layer; and

a gate layer including a plurality of conductive lines located adjacent to the insulation layer, wherein each of the conductive lines is aligned with a portion of the converging electrode layer between one pair of neighboring rows of the first apertures.

- 8. The mesh structure of Claim 7, wherein the gate layer further comprises a hollow frame within which the conductive lines extend.
- 15 9. The mesh structure of Claim 7, wherein each of the second apertures is aligned with one corresponding first aperture.
 - 10. The mesh structure of Claim 7, wherein each of the second apertures is aligned with a plurality of corresponding first apertures.
- 11. A method of fabricating a mesh structure mounted between an anode
 20 plate and a cathode plate of a tetra-polar field-emission display, comprising:
 providing a first conductive plate;

forming a plurality of first apertures extending through the first conductive plate;

providing a glass plate to server as a spacer;

forming a plurality of second apertures extending through the glass plate; temporally attaching the glass plate to one side of the first conductive plate with the second apertures aligned with the first apertures; providing an insulation layer formed on the other side of the first conductive plate;

providing a second conductive plate;

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forming a plurality of third apertures extending through the second conductive plate;

temporally attaching the second conductive plate to the insulation layer with the third apertures aligned with the first and second apertures; and

permanently stacking the glass plate, the first conductive plate, the insulation plate and the second conductive plate to form the mesh structure.

- 12. The method of Claim 11, wherein the step of temporally attaching the glass plate to the first conductive plate includes applying an ultra-violet glue therebetween.
- 13. The method of Claim 11, wherein the step of temporally attaching the second conductive plate to the insulation layer includes applying an ultra-violet glue therebetween.
- 14. The method of Claim 11, wherein the step of permanently stacking the glass plate, the first conductive plate, the insulation plate and the second conductive plate includes a high-temperature sintering process.
- 15. The method of Claim 11, further comprising providing the first and second conductive layer fabricated from a material having a thermal expansion coefficient similar to that of the anode plate and the cathode plate.
 - 16. The method of Claim 11, further comprising providing the glass plate having a thermal expansion coefficient similar to that of the anode plate and the cathode plate.
 - 17. The method of Claim 11, wherein the insulation layer is a glass glue.